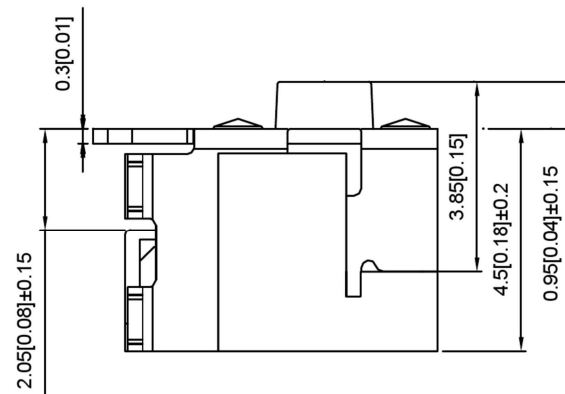
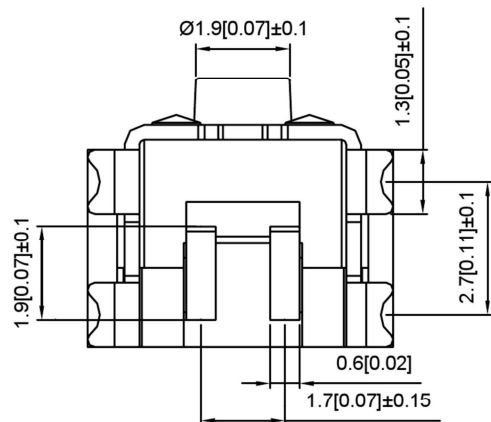
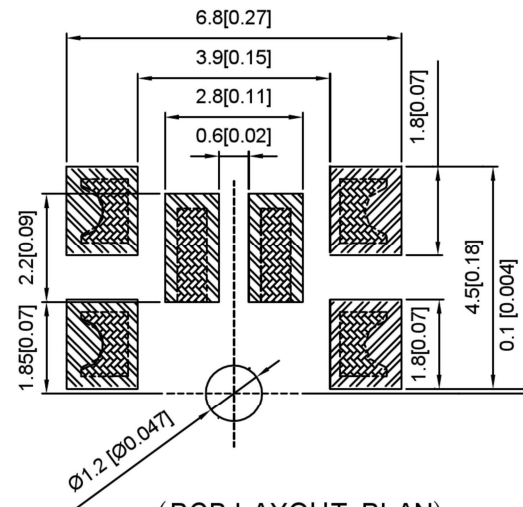
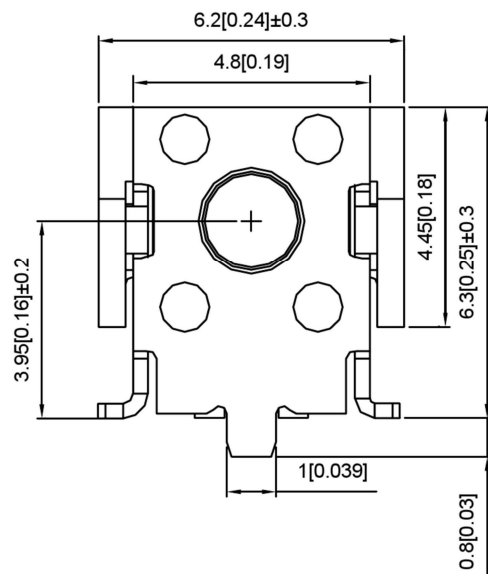




SPECIFICATION

Contact Rating:	50mA, 12V DC
Contact Resistance:	100mΩ max
Insulation Resistance:	100mΩ min. 500V DC
Dielectric Strength:	250V AC/1minute
Travel:	0.25mm
Operating Temp:	-30℃~+85℃
Storage Temp:	-30℃~+80℃



(PCB LAYOUT PLAN)



(CIRCUIT DIAGRAM)

PAPT NO	TS-1109TP-X
Operating Force	A:100gf B:160gf C:260gf
Height	H:3.85

⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Pa46		—
②	Cover	—	1	Spcc	Plating Nickel	—
①	Keystake	—	1	Pa46		—
ITEM	PAPT NAME	TER,NO	QTY	MATERIAL	FINISHING	REMARK

				ANGLAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
	DATE	REVISED	APPROVED	L > 63	±0.5
					UNSPECIFIED TOLERANCES
www.alpsr.com www.adxidz.com www.xbswitch.com					



DSND		SCALE: N/A	MODEL TYPE: TACT SWITCH
DWN		VIEW:	PART NO.: TS-1109TP-X
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
		WEIGHT	SHEET
		1/1	REVISIO
			A0

DONG GUAN XI BANG ELECTRONIC CO., LTD